



P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)}(\Omega)$ I_{D}			
-30	0.018 @ V _{GS} = -10 V	-11.7		
	0.030 @ V _{GS} = -4.5 V	-9.0		

FEATURES

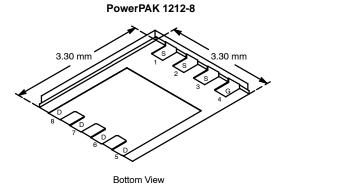
- TrenchFET® Power MOSFET
- New PowerPAK® Package
 - Low Thermal Resistance, R_{thJC}
 - Low 1.07-mm Profile



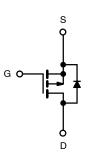
RoHS COMPLIANT

APPLICATIONS

Battery Switch



Ordering Information: Si7423DN-T1—E3 (Lead (Pb)-Free)



P-Channel MOSFET

Parameter		Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage		V _{DS}	-30			
Gate-Source Voltage		V _{GS}	±20		V	
Continuous Drain Coment /T. 45090\8	T _A = 25°C	I _D	-11.7	-7.4	Α	
Continuous Drain Current (T _J = 150°C) ^a	T _A = 85°C		-8.4	-5.4		
Pulsed Drain Current		I _{DM}	-30		A	
continuous Source Current (Diode Conduction) ^a		I _S	-3.2	-1.3		
Maximum Power Dissipation ^a	T _A = 25°C	В	3.8	1.5	W	
	T _A = 85°C	- P _D	2.0	0.8		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b,c}			260		•0	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 10 sec	R _{thJA}	26	33		
Maximum Junction-to-Ambient ^a	Steady State		65	81	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	1.9	2.4		

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. See Solder Profile (http://www.vishay.com/doc?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.



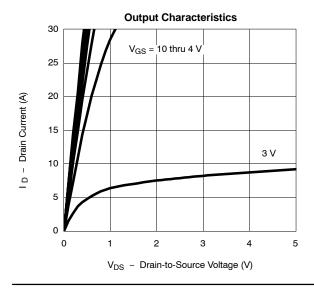
SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)								
Parameter	Symbol	Test Condition		Тур	Max	Unit		
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1		-3	V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA		
		V _{DS} = -30 V, V _{GS} = 0 V			-1	<u> </u>		
Zero Gate Voltage Drain Current	DSS	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 85^{\circ}\text{C}$			-5	μΑ		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \leq -5 \text{ V}, V_{GS} = -10 \text{ V}$	-30			Α		
Dunin Course On Otata Basistanas	_	$V_{GS} = -10 \text{ V}, \ I_D = -11.7 \text{ A}$		0.014	0.018	0		
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -9.0 \text{ A}$		0.023	0.030	Ω		
Forward Transconductancea	9fs	V _{DS} = -15 V, I _D = -11.7 A		29		S		
Diode Forward Voltage ^a	V _{SD}	$I_S = -3.2 \text{ A}, V_{GS} = 0 \text{ V}$		-0.76	-1.2	V		
Dynamic ^b								
Total Gate Charge	Qg			37.5	56	nC		
Gate-Source Charge	Q _{gs}	V_{DS} = -15 V, V_{GS} = -10 V, I_D = -11.7 A		5.8				
Gate-Drain Charge	Q _{gd}			9.6				
Gate Resistance	R _g	f = 1 MHz		5		Ω		
Turn-On Delay Time	t _{d(on)}			11	20	ns		
Rise Time	t _r	$V_{DD} = -15 \text{ V, R}_{1} = 15 \Omega$		10	15			
Turn-Off Delay Time	t _{d(off)}	V_{DD} = -15 V, R_L = 15 Ω $I_D \cong -1$ A, V_{GEN} = -10 V, R_g = 6 Ω		74	110			
Fall Time	t _f			50	75			
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = -3.2 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		30				

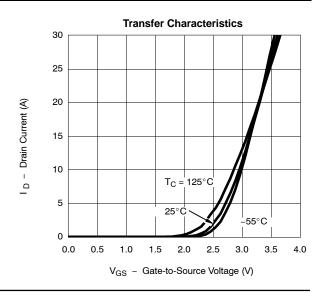
Notes

- Pulse test; pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

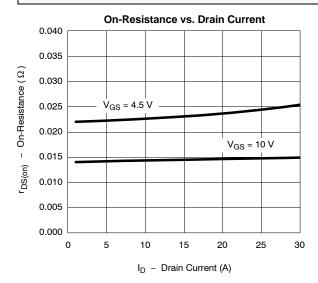


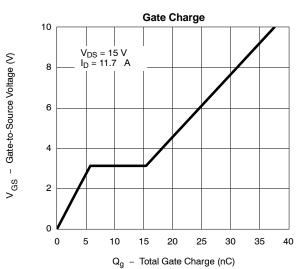


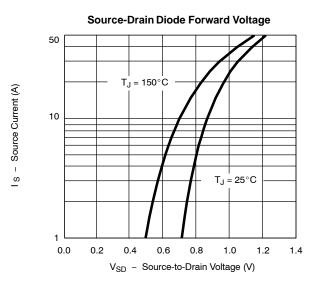


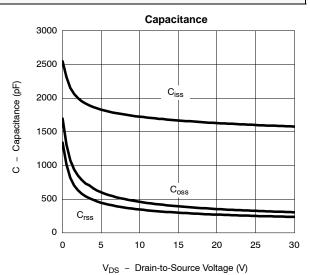


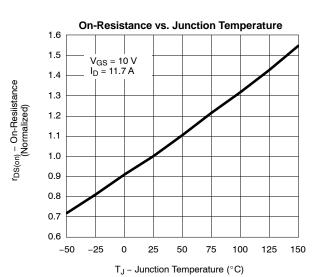
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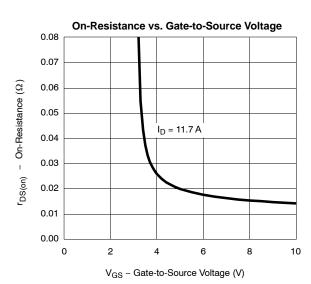






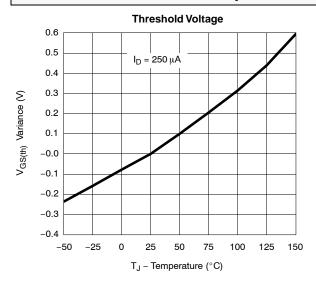


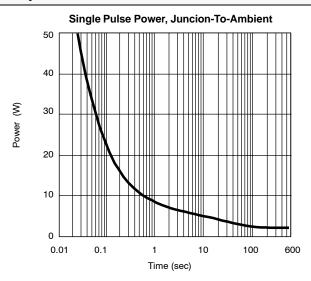


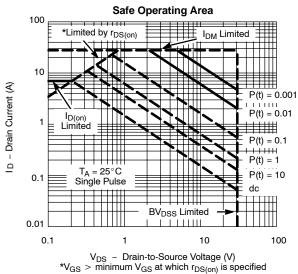




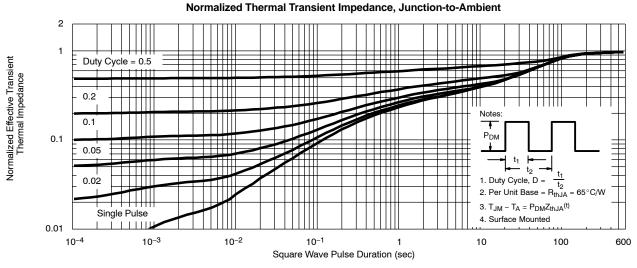
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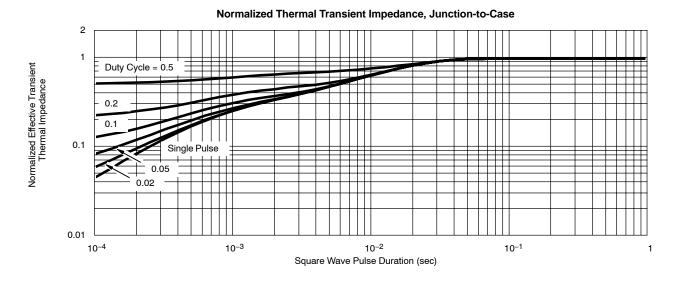


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TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



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